

ngspice, development update and electrothermal simulation

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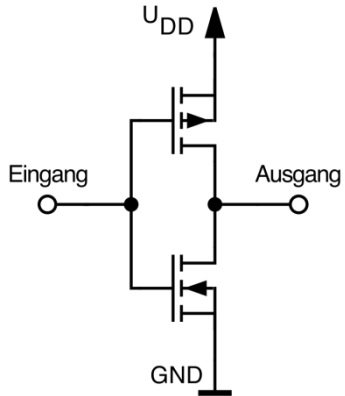
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ngspice – what is it ?

Circuit simulator that numerically solves equations describing (electronic) circuits made of passive and active devices for (time varying) currents and voltages

Open source successor of venerable spice3f5 from Berkeley



CMOS inverter

```
.include ./bsim4soi/nmos4p0.mod
.include ./bsim4soi/pmos4p0.mod
.option TEMP=27C

Vpower VD 0 1.5
Vgnd VS 0 0

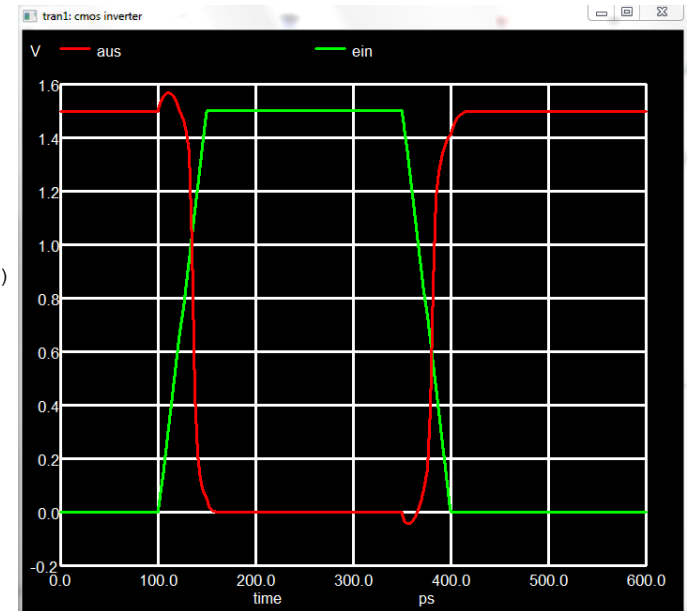
Vgate Ein VS PULSE(0 1.5 100p 50p 50p 200p 500p)

MN0 Aus Ein VS VS N1 W=10u L=0.18u
MP0 Aus Ein VD VS P1 W=20u L=0.18u

.tran 3p 600ps

.control
  run
  plot Ein Aus
.endc

.END
```



the circuit

the input

the output

The two major application areas

PCB design support

Circuits are made with a mix of ICs and discrete components

Requirements:

Comfortable user interface
(offered by third parties)

PSPICE and LTSPICE model
compatibility

KiCad, Eagle, PartSim,
CoolCAD, PSIM, WeSpice ...

IC design support

Circuits are made of (MOS)
transistors and (parasitic)
passive components

Requirements:

BSIM 3, 4, (BULK) models etc.

Large circuit capability, speed
HSPICE PDK compatibility

gEDA, Yosys, eFabless, Isotel,
XSCHEM, PySpice ...

Towards ngspice-32 (03/2020)



Improved graphics

Text orientation,
fonts, color,
linewidth selections

Monte Carlo

Improved statistical
IC analysis

UNICODE support

utf-8 and wide-char
for strings:

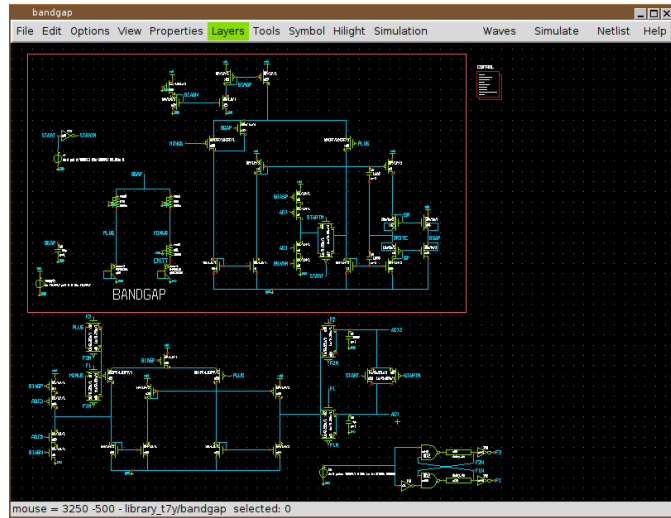
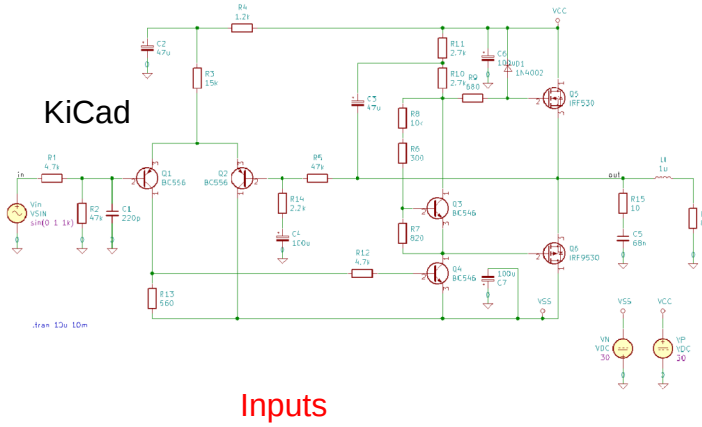
Text in plots, node
names, file and
directory names

Revised VDMOS model

efficient model for
power MOS
transistors, now
includes self heating
(electrothermal
model)

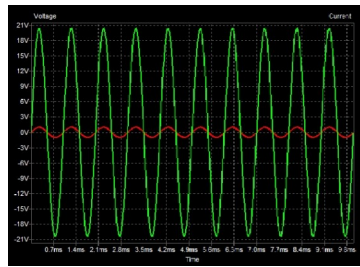
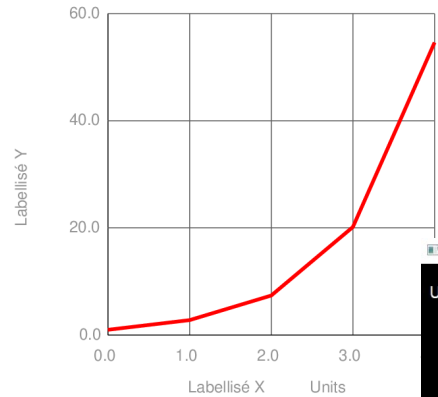
In addition: major code cleanup, enhanced robustness against
buggy input, improved error handling, improved convergence

Some impressions

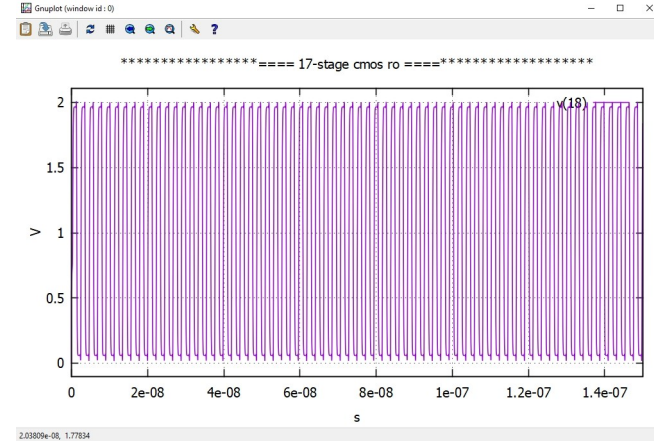


XSCHEM

Postscript
const: Titré Äü @µα~
Units — y

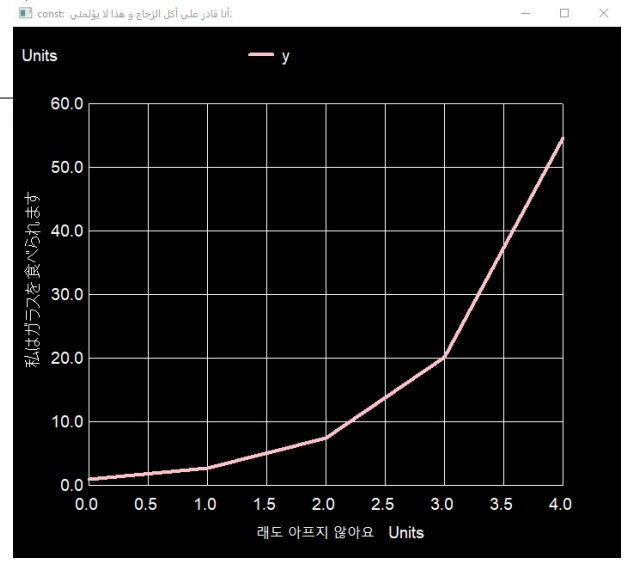


KiCad



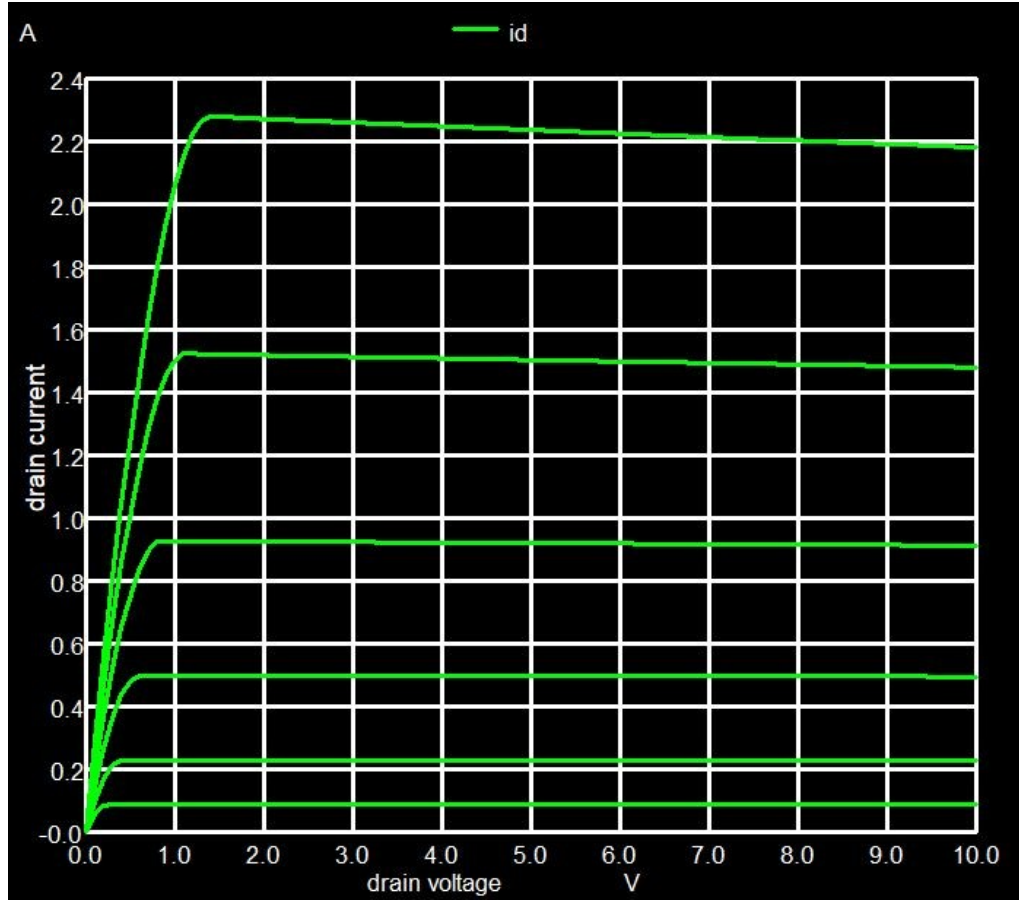
gnuplot

Outputs



UNICODE axis labels

Temperature influence on devices



Power MOS

Drain voltage is rising,
current is decreasing?

=> Temperature effect!

Electric power => heat
=> temperature

Mobility is decreasing
with temperature.

**=> How to model this
effect?**

Electro-thermal modelling

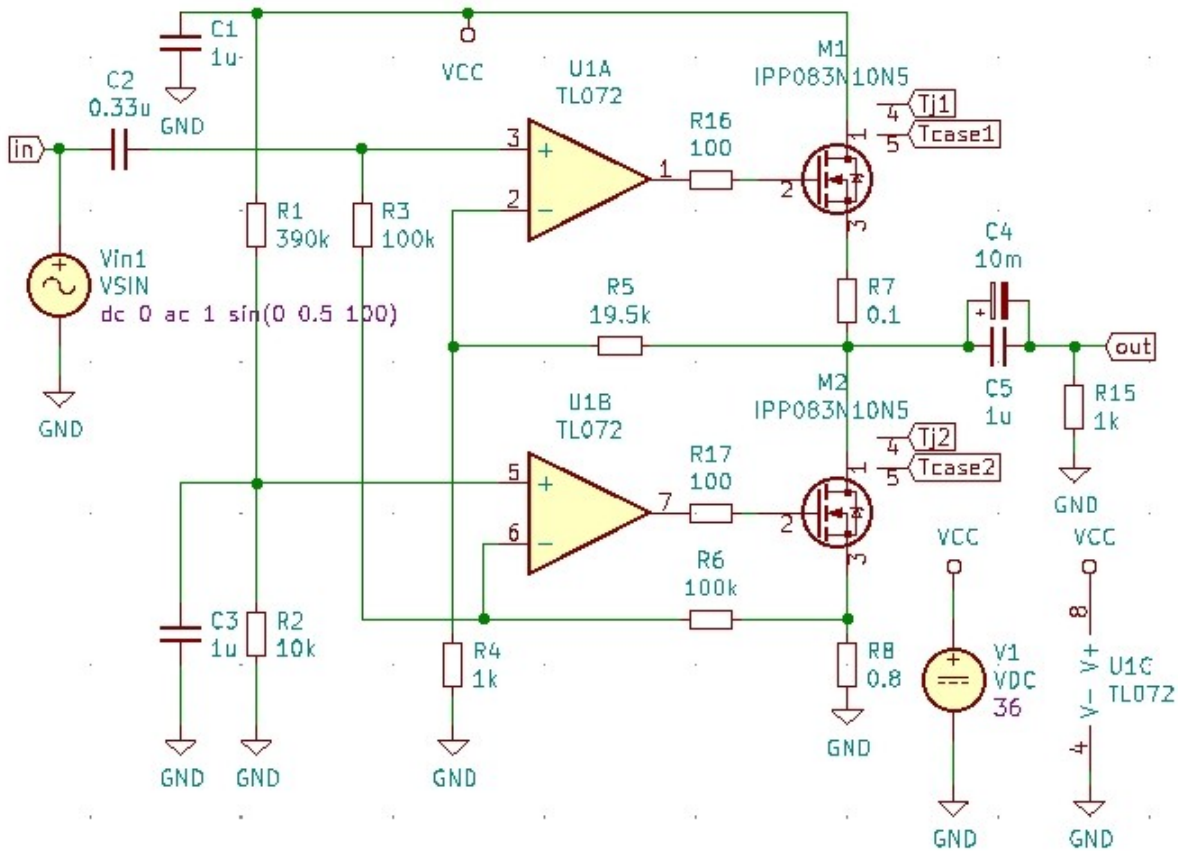
Make use of the equivalence of electronic and thermal properties (circuits).

Translate thermal to electrical circuits, run both circuit parts in ngspice. Electrical power dissipation generates heat, restricted heat flow rises temperature, temperature changes power dissipation.

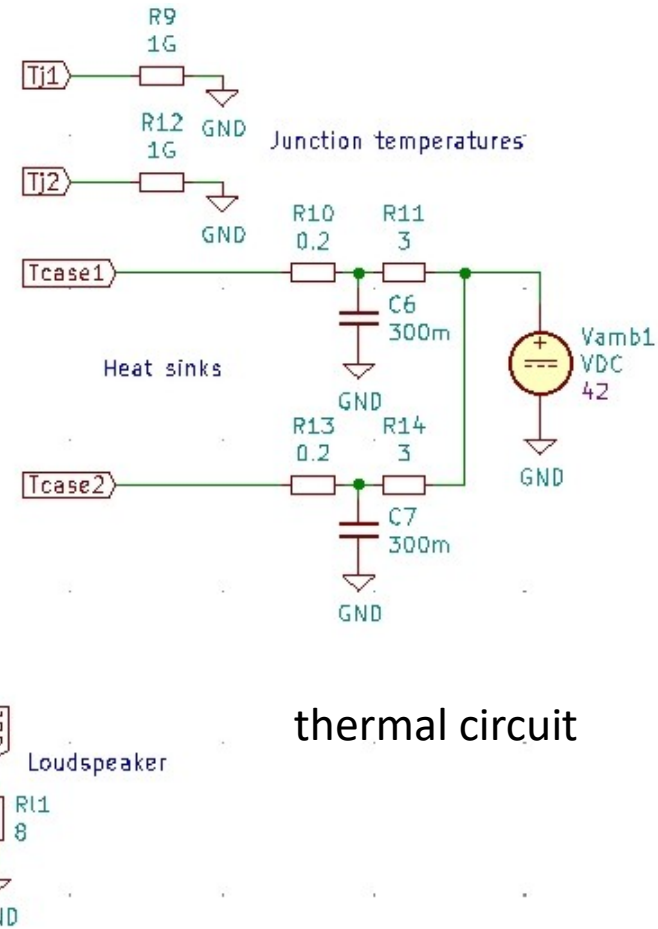
	Thermal term	Electrical term
<i>Capacitance</i>	c [J/K]	C [A/V]
<i>Conductance</i>	g [W/K]	$1/R$ [1/ Ω]
<i>Temperature/Voltage</i>	$T(t)$ [K]	$V(t)$ [V]
<i>Heat/Current</i>	Q [W]	$I(t)$ [A]
<i>Time constant</i>	c/g [s]	RC [s]

Example: Amp with power MOS

<http://www.tubecad.com/2009/08/blog0168.htm>



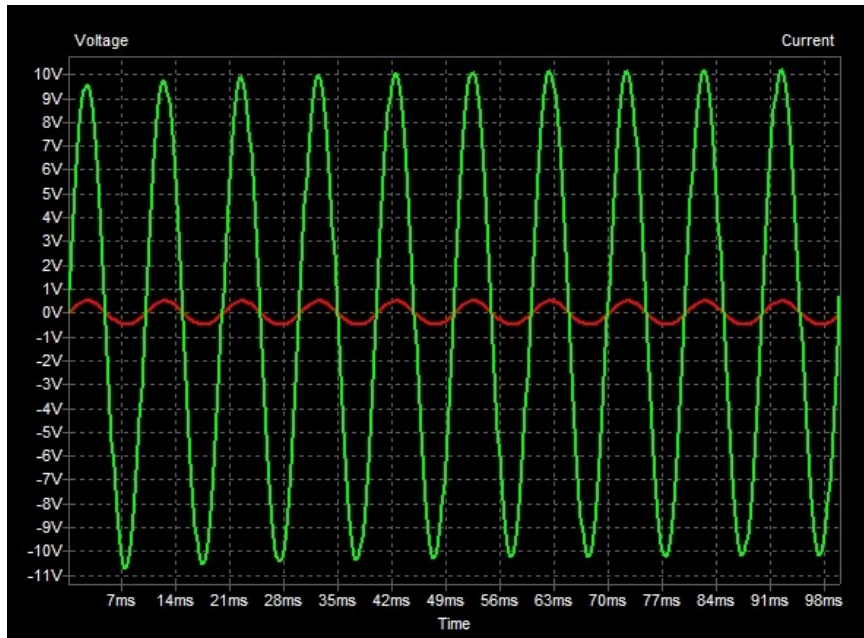
electric circuit



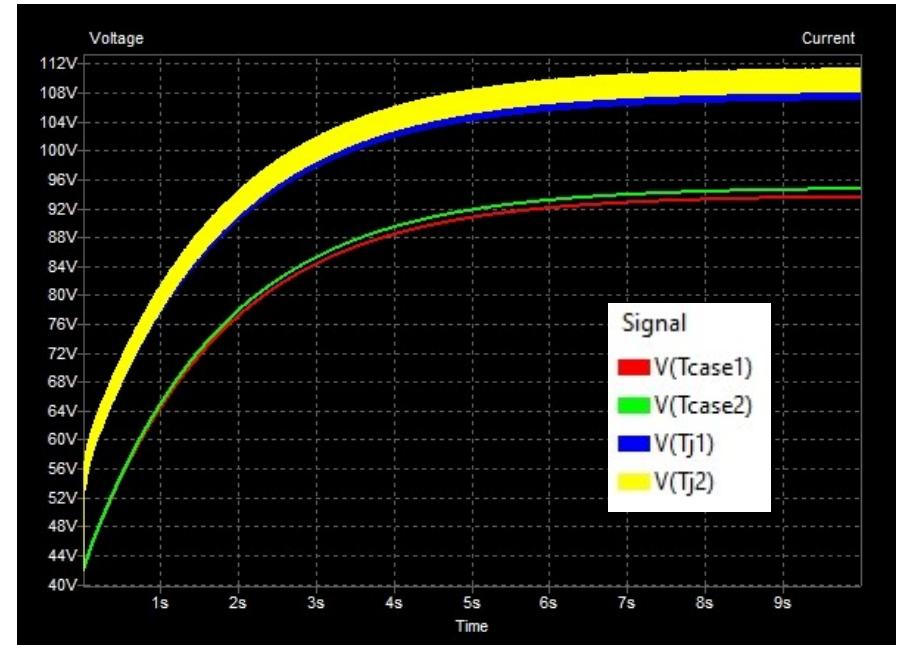
thermal circuit

Amplifier electro-thermal simulation results

Integrated signal
and temperature
simulation



Amplifier input and output voltages.
Simulated for 100 ms at 42 °C (similar curve results at 108 °C)



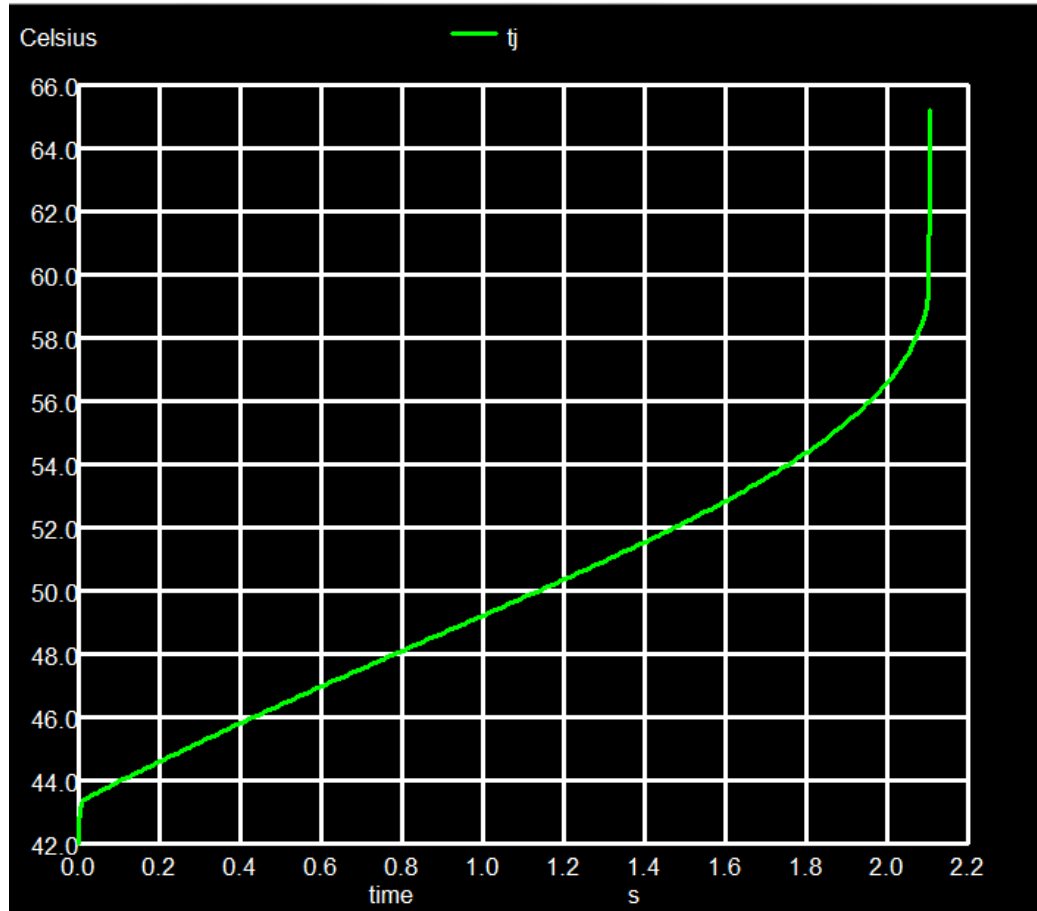
Transistor case and transistor junction temperatures.
Simulated for 10 s with Tj rising from 42 to 108 °C

Modelling of thermal runaway

Resistor with negative
temperature coefficient
 1Ω , 1 V , $-0.03 \Omega/\text{K}$

After some time the
temperature rises
beyond bounds

=> thermal runaway
device destruction



Summary

Ngspice-32 will be available in March 2020 with several new features:

- Many bug fixes and improved error messages
- Electro-thermal simulation with VDMOS Power MOS model
- UNICODE compatibility
- Enhanced Monte Carlo simulation capability

And even then: Still a lot to do for ngspice-33...